Electronic transport in modulation-doped InSb quantum well heterostructures


1QinetiQ Malvern WR14 3PS, United Kingdom
2School of Electrical and Electronic Engineering, University of Manchester, Manchester M60 1QD, United Kingdom
3Department of Physics, Imperial College, London SW72AZ, United Kingdom

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The mobility and carrier concentration of a number of InSb-based modulation-doped quantum well heterostructures are examined over a range of temperatures between 4.5 and 300 K. Wide well (30 nm) and narrow well (15 nm) structures are measured. The temperature dependent mobilities are considered within a scattering model that incorporates polar optical and acoustic phonon scatterings, interface roughness scattering, and scattering from charged impurities both in the three-dimensional background and with a distributed “quasi-two-dimensional” doping layer. Room temperature mobilities as high as 51 000 cm$^2$/V·s are reported for heterostructures with a carrier concentration of $5.8 \times 10^{11}$ cm$^{-2}$, while low-temperature mobility (below 40 K) reaches 248 000 cm$^2$/V·s for a carrier concentration of $3.9 \times 10^{11}$ cm$^{-2}$. A Schrödinger–Poisson model is used to calculate band structures in the material and is shown to accurately predict carrier concentrations over the whole temperature range. Low-temperature mobility is shown to be dominated by remote ionized impurity scattering in wide well samples and by a combination of ionized impurity and interface roughness scattering in narrow well samples.

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I. INTRODUCTION

Electronic transport in remotely doped heterostructures is a subject of significant interest in the fields of high-speed electronics (high electron mobility transistors) and ballistic mesoscopic devices, as well as for magnetic sensor applications, in which a high electron saturation velocity leads to enhanced magnetic sensitivity. In devices for which ballistic transport is a requirement, it is necessary to optimize both the carrier mobility and the concentration in the two-dimensional electron gas (2DEG) since the ballistic electron mean free path, $l_e$, at low bias, is directly proportional to the mobility, $\mu$, and the square root of the carrier concentration, $n_e$,

$$l_e = \left( \frac{\hbar}{e^2} \right) \mu \sqrt{n_e}. \quad (1)$$

Given the large lattice mismatch between InSb and its potential alloy materials, high-quality growth is challenging and InSb-based heterostructures are, as a result, not yet widely studied. However, when compared to far more common GaAs-based materials systems, InSb-based heterostructures offer several intrinsic advantages, such as the lowest bulk electron effective mass of any III–V semiconductor (0.014me), a large dielectric constant (16.8e0), the narrowest band gap of any III–V semiconductor (170 meV at room temperature), and an exceptionally large Landé g factor (−51), which could lead to important applications in spin-to-charge readout and selective qubit addressing in quantum computing. Electronic behavior in GaAs has been well understood for many years, but it is only comparatively recently that high-quality InSb heterostructures have been fabricated and characterized. The resulting electron mobilities are sufficient to exhibit ballistic transport effects in mesoscopic structures, such as one-dimensional (quantum wire) transport in etched and soft-confined (gated) quantum point contacts. In this paper, we report the growth and characterization of high-mobility InSb/Al$_{x}$In$_{1−x}$Sb heterostructures with a single Te delta-doping plane, which have been shown to operate under Schottky-barrier surface gating for device applications. We include results of the effects induced by variation in spacer thickness between the quantum well and the single Te-doping plane, and we present results on the variation of the width of the quantum well and the composition of barrier materials and dopant concentration, with a view to optimizing the materials system for high-speed or mesoscopic transport. We use a transport lifetime model, which is based on the relaxation time approximation, to examine the contributions of individual scattering mechanisms in the electron transport.

II. GROWTH AND FABRICATION

The InSb/Al$_{x}$In$_{1−x}$Sb heterostructure was grown by solid-source molecular beam epitaxy (MBE) on a semi-insulating GaAs substrate. Two types of structure were grown: one with a 30 nm InSb quantum well layer [Fig. 1(a)] and the other with a 15 nm InSb quantum well layer [Fig. 1(b)]. The wider well samples consist of, in growth order, an accommodation layer, a 3 $\mu$m Al$_{0.1}In_{0.9}$Sb buffer layer, a 30 nm InSb quantum well, and a 50 nm upper barrier layer of Al$_{0.15}In_{0.85}$Sb. The narrower well samples consist of the same accommodation layer, a wider band gap 3 $\mu$m buffer layer of Al$_{0.15}In_{0.85}$Sb, and a 15 nm InSb quantum well followed by a 50 nm Al$_{0.3}In_{0.7}$Sb top barrier. Within the upper barrier layer, which is separated from the well by a spacer, d, is a Te δ-doping plane. Postgrowth secondary ion mass spectrometry (SIMS) studies show Te-dopant atoms distributed through the top barrier with an exponential decay in concentration in the growth direction, away from the quantum well.
(this is superimposed onto the Schrödinger–Poisson solutions in Fig. 1).

The material is intentionally depletion mode and is designed to operate under negative biases supplied by Schottky contacts on the surface. The doping and alignment are such that the equilibrium Fermi energy falls above the first confined state, so that the conduction band bound states are populated at all temperatures. These layers form a type-I heterostructure, which provides confinement for both electrons and holes in the channel layer. Schrödinger–Poisson solutions for the band structure of these layers are shown in Fig. 1(a) at 300 K. The low-contact technology is employed to ensure that transport is via the 2D channel only. Evidence for single subband electrons and holes in the channel layer. Schrödinger–Poisson solutions for the band structure of these layers are shown in Fig. 1(b). Midgap pinning is assumed at the surface, and the spatially varying Te concentration is taken into account by calculating the Schrödinger–Poisson equations for 30 nm layers at 10 K. The low-contact technology is employed to ensure that transport is via the 2D channel only. Evidence for single subband electrons and holes in the channel layer. Schrödinger–Poisson solutions for the band structure of these layers are shown in Fig. 1 (right hand side, for a carrier concentration of 3.8x10^11 cm^-2). Wide and narrow well structures are presented in Fig. 1(a), right hand side, for a carrier concentration of 4.8x10^11 cm^-2. Midgap pinning is assumed at the surface, and the spatially varying Te concentration is taken into account by calculating the Schrödinger–Poisson solutions for the structure that allows the temperature dependence of the carrier concentration measurements to be modeled. The modeled points in Fig. 2 (filled circles) demonstrate a good fit with the data, which indicates that the Schrödinger–Poisson model provides a realistic representa-
tion of the electronic band structure and carrier densities over the studied temperature range. The origin of the changing carrier concentration with temperature derives from a combination of the temperature dependence of the band structure and the thermal activation of higher energy subbands. Although we cannot completely exclude the possibility of unionized donors, the good agreement with experimental data shown in Fig. 2, assuming fully ionized donors, gives a high level of confidence: the degree of donor ionization is not a major contribution to the channel carrier density. For the samples reported here, the measured carrier concentrations vary between \((3.7–5.1) \times 10^{11} \text{ cm}^{-2}\) at 10 K and \((5.1–8.0) \times 10^{11} \text{ cm}^{-2}\) at 300 K for the wide well samples and between \((2.8–5.7) \times 10^{11} \text{ cm}^{-2}\) at 10 K and \((3.7–6.0) \times 10^{11} \text{ cm}^{-2}\) at 300 K for the narrow well samples.

Figure 3 shows the Hall mobility for a range of narrow well heterostructures as a function of temperature, with 20, 10, and 5 nm spacers between the quantum well and the doping plane. Below 50 K, the mobility of all samples remains roughly constant. The low-temperature mobilities are 11 000, 72 300, and 63 600 \(\text{cm}^2/\text{V}s\) for the 20, 10, and 5 nm spacer samples, respectively. Above 50 K, the mobility drops off with temperature, with the curves converging above 250 K. At 300 K, the mobilities of all of the narrow well samples are approximately 40 000 \(\text{cm}^2/\text{V}s\). The inset in Fig. 3 shows the low-temperature mobilities as a function of spacer separation. The error bars are consistent with the spread of data for similar devices of the same wafer growth, from which an exponential fit between mobility and spacer is demonstrated (solid line).

The temperature dependence of the mobility in wide well samples is shown in Fig. 4. The two samples presented show low-temperature mobilities far in excess of those measured for the narrower wells, with 10 K mobilities of 248 000 \(\text{cm}^2/\text{V}s\) for the 25 nm spacer sample (W1) and 214 600 \(\text{cm}^2/\text{V}s\) for the 20 nm spacer sample (W2). The mobility in both samples remains constant below 40 K (a slightly lower temperature than that observed in the narrower well samples); again, the mobilities converge at higher temperatures, with 300 K mobilities of 52 000 \(\text{cm}^2/\text{V}s\) (W1) and 48 000 \(\text{cm}^2/\text{V}s\) (W2).

The 300 K mobilities and carrier concentrations of the samples named in Table I, together with data from a number of additional layers of similar construction, are shown in Fig. 4.

### Table I. InSb/Al\textsubscript{1-x}In\textsubscript{x}Sb heterostructure samples presented in this paper.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Well width (nm)</th>
<th>Spacer (nm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>W1</td>
<td>30</td>
<td>25</td>
</tr>
<tr>
<td>W2</td>
<td>30</td>
<td>20</td>
</tr>
<tr>
<td>N1</td>
<td>15</td>
<td>20</td>
</tr>
<tr>
<td>N2</td>
<td>15</td>
<td>10</td>
</tr>
<tr>
<td>N3</td>
<td>15</td>
<td>5</td>
</tr>
</tbody>
</table>

FIG. 2. Measured carrier concentration of W2 as a function of temperature. The carrier concentrations calculated from Schrödinger–Poisson solutions for this structure are shown as filled circles.

FIG. 3. Temperature-dependent mobility of narrow (15 nm) well InSb heterostructures with 20, 10, and 5 nm spacers from Hall measurements taken between 4.5 and 300 K. The inset shows low-temperature mobility as a function of spacer separation (open squares). These data are consistent with exponential behavior (solid line).

FIG. 4. Temperature-dependent mobility of wide (30 nm) well InSb heterostructures with 25 and 20 nm spacers from Hall measurements taken between 4.5 and 300 K.
The scattering of electrons by absorption of light and Ridley. The characteristic transport lengths for electrons in these heterostructures to be 37 600 to 51 100 cm

The data in Fig. 5 show that the mobility in the wide well structures ranges from 37 600 to 51 100 cm²/V s, while in the narrow well structures the mobility varies between 34 500 and 39 900 cm²/V s at 300 K. It is also notable that the spacer distance in the narrow well layers seems to be of less significance to the room temperature transport characteristics of the samples.

IV. DISCUSSION AND TRANSPORT LIFETIME MODEL

Within the transport formalism of the relaxation time approximation, the electron drift under applied fields is opposed by a scattering term, which is characterized by the momentum relaxation time, or transport lifetime, \( \tau_{\text{tr}} \). We recognize the limitation of this approximation, especially in the context of narrow-gap semiconductors; however, it does enable ready comparison of the relative importance of the various scattering mechanisms. A detailed theoretical treatment of scattering in this material is currently the subject of additional investigation.\(^{13}\) The scattering of an electron wave packet in a crystalline material consists of a variety of mechanisms that are individually well characterized and have temperature dependences that explain the overall characteristics observed in the mobility of particular heterostructures. It is important that at certain temperatures, such as the cryogenic temperature ranges, the mobility may be strongly dominated by one particular scattering mechanism. This can be used to engineer and, in general, maximize the mobility so as to increase the ballistic transport length or device performance.

The most significant scattering mechanisms are well recognized in III–V semiconductors,\(^{14,15}\) and the total transport lifetime, \( \tau_{\text{tr}} \), can be calculated from the sum of individual scattering rates. These may be separated into two broad categories: phonon scattering—wherein perturbations to the lattice potential affect the electronic transport—and ionized impurity scattering—wherein electrons are influenced by the potentials of both remote and background impurities via the Coulomb interaction. This list is by no means exhaustive; indeed, scattering by uncharged material defects in the lattice and interface roughness scattering can also have a significant limiting effect on the mobility.

The principal contributions to phonon scattering are from polar phonons in the optical branch (\( \tau_{\text{po}} \)) and acoustic phonons (\( \tau_{\text{ac}} \)), while for impurity scattering, background impurities (\( \tau_{\text{bg}} \)) and remote ionized impurities in the doping layers (\( \tau_{\text{ni}} \)) are important. The scattering rates from these processes may be derived from Fermi’s golden rule.

 Phonon scattering in semiconductors is well documented.\(^{15–21}\) The scattering of electrons by absorption of polar optical phonons in quantized 2D heterostructures has been considered by Price\(^{21}\) and Ridley.\(^{17}\) The characteristic lifetime for a quantum well of width \( w \) is given by

\[
\frac{1}{\tau_{\text{po}}} = \frac{e^2 \omega_0 N(\omega_0) m^2 w}{4 \pi \epsilon_0 \hbar^2},
\]

where \( \epsilon_0^1 = \epsilon_0 - \epsilon_s \) and \( \epsilon_s \) and \( \epsilon_0 \) are the high-frequency and static dielectric constants, respectively. \( \hbar \omega_0 \) is the optical phonon energy and \( N(\omega_0) \) gives the density of phonons, where

\[
N(\omega_0) = \left[ \exp \left( \frac{\hbar \omega_0}{k_B T} \right) - 1 \right]^{-1}.
\]

In the above expression, it is assumed that there is no intersubband scattering; this is reasonable in systems wherein the subband spacing \( \Delta E \) is sufficiently large that phonon absorption cannot induce a change of transverse mode.

The acoustic phonon scattering depends on the deformation potential \( \Xi \) of the phonon in the lattice, the crystal density \( \rho_0 \), and the longitudinal sound velocity \( v_L \).\(^{14,16}\) Again, assuming that there is no intersubband scattering,

\[
\frac{1}{\tau_{\text{ac}}} = \frac{3 m^* \Xi^2 k_B T}{2 \hbar^3 \rho_0 v_L^2 w}.
\]

Impurity scattering can be an important mechanism, particularly at low temperatures, at which phonon scattering is weak. Much work exists on the modeling of scattering from charged impurities, both localized and distributed throughout the lattice, within more common heterostructures, such as those based on GaAs. The analysis here follows that of Davies.\(^{22}\)

The long-range Coulomb interaction between the ions and the electrons is described by the perturbation Hamiltonian \( \hat{V} \).
Following the Born approximation, the perturbation matrix element is expressed in terms of the two-dimensional Fourier transform of the scattering potential, \( \hat{V}(q) \). From Fermi’s golden rule, the scattering rate from \( k \) to \( k + q \) is

\[
W_{k \rightarrow k+q} = \frac{2\pi}{A^2h} |\hat{V}(q)|^2 \delta(\epsilon(k+q) - \epsilon(k)),
\]

where the delta function is consistent with elastic scattering. The scattering angle is related to \( |q| = q \), via \( \theta = 2\sin^{-1}(q/2k) \). The dependence of Eq. (5) on \( 1/A^2 \) reflects the fact that as the system grows, the scattering from a single impurity becomes less important. This factor disappears if we consider a two-dimensional density of scattering states and an average area distribution of impurities; thus, the average scattering rate \( \langle \tau_d \rangle \) is independent of device dimensions. Circularly symmetric scattering potentials introduce an appropriate expression for the Fourier transformed scattering of the electron. It then remains to substitute the transport lifetime, \( \tau_{tr} \), where

\[
\frac{1}{\tau_{tr}} = \frac{n^{2D}_{\text{imp}}}{2\pi \hbar^3 k_f^3} \int_0^{2k_f} |\hat{V}(q)|^2 \frac{q^2 dq}{1 - (q/2k_f)^2},
\]

and since all conduction takes place close to the Fermi energy in a degenerate two-dimensional semiconductor, we can take \( k = k_f = \sqrt{2m_e} \), where \( n_e \) is the sheet carrier electron concentration. The integral in Eq. (6) runs between 0 and \( 2k_f \), where a scattering wave vector of \( q = 2k_f \) implies total backscattering of the electron. It then remains to substitute the appropriate expressions for the Fourier transformed scattering potentials for either remote ionized or background impurities.

First, the scattering from remote ionized impurities is considered for a two-dimensional sheet of charged impurities, \( n_{\text{imp}}^{2D} \), separated from the quantum well by a spacer \( d \) by taking the Fourier transform of the Coulomb potential. The effects of screening are included by using the Thomas–Fermi approximation. The remote ionized impurity scattering rate for a two-dimensional sheet of impurity atoms at \( d \) is then

\[
\frac{1}{\tau_{\text{tr}}} = \frac{n_{\text{imp}}^{2D} m^*}{2\pi \hbar^3 k_f^3} \left( \frac{e^2}{2\epsilon_0 \epsilon_s} \right)^2 \int_0^{2k_f} \frac{q^2 dq}{(q + q_T)^2 \sqrt{1 - (q/2k_f)^2}}.
\]

The transport lifetime associated with background impurities is found by integrating over a three-dimensional (3D) distribution of scattering centers as follows:

\[
\frac{1}{\tau_{bgi}} = \frac{n_{\text{imp}}^{3D} m^*}{2\pi \hbar^3 k_f^3} \left( \frac{e^2}{2\epsilon_0 \epsilon_s} \right)^2 \int_0^{2k_f} \frac{q dq}{(q + q_T)^2 \sqrt{1 - (q/2k_f)^2}}.
\]

The bounds of the integrals in Eqs. (7) and (8) refer to scattering angles between 0 and 180°. The assumption of a perfect delta-doping plane at \( d \) leads to an overestimation of the scattering because, in reality, some surface transport of the Te atoms occurs during the growth. SIMS reveals a Te composition, which exponentially decays in concentration from \( d \) toward the surface in the growth direction (see Fig. 1). To incorporate this into the ionized impurity model [Eq. (6)], the impurity distribution is considered a function of \( d \), over the range \( d_s \) (at the spacer) to \( d_q \) (at the surface), so that we obtain a modified expression for ionized impurity scattering as follows:

\[
\frac{1}{\tau_{\text{tr}}} = \frac{m^*}{2\pi \hbar^3 k_f^3} \left( \frac{e^2}{2\epsilon_0 \epsilon_s} \right)^2 \int_{d_s}^{d_q} \int_0^{2k_f} n_{\text{imp}}^{2D}(d) \exp(-2q|d|) \frac{q^2 dqdd}{(q + q_T)^2 \sqrt{1 - (q/2k_f)^2}}.
\]

A further source of scattering, which is exclusive to heterostructure systems, comes from variation in the interfaces at the edges of the quantum well. Roughness at these interfaces causes the energy of the confined states to change as the width of the confinement changes. This has been studied by Hong et al.\(^{23}\) for a quasitriangular single heterointerface, where a strong dependence on well width is observed. For type-I aligned heterostructures, the dependence of the 2DEG ground-state energy on quantum well dimensions can be considered, to a first approximation, by referring to solutions to the time-independent Schrödinger equation in an infinite square well.\(^{24,25}\) The deviation from a perfectly flat interface is described by the function \( \Delta(r) \), where \( r \) covers the \((x,y)\) plane in which the interface is defined. \( \Delta \) is the rms average variation in the interface in the \( z \) direction, which is usually of the order of a few monolayers for MBE-grown heterostructures,\(^{24}\) and \( L \) is the characteristic extent of the roughness features. These quantities may be found by standard imaging techniques, such as cross-sectional transmission electron microscopy or atomic force microscopy.

The scattering rate is calculated from the Born approximation [as Eq. (5)] by using the square of the interface scattering matrix element given in Refs. 24–26,

\[
|\hat{V}(q)|^2 = \pi^2 \hbar^4 \Delta^2 L^2 \frac{m^* w^2}{e^2} \exp\left(-\frac{q^2 L^2}{4}\right).
\]

As before [Eq. (6)], the transport lifetime associated with interface roughness is expressed in terms of the scattering wave vectors as

\[
\frac{1}{\tau_{\text{int}}} = \frac{\pi^2 \hbar^4 \Delta^2 L^2}{2m^* w^2 k_f^3} \int_0^{2k_f} \exp\left(-\frac{q^2 L^2}{4}\right) \frac{q^2 dq}{\sqrt{1 - (q/2k_f)^2}}.
\]

The transport lifetime in this analysis is extremely sensitive to the well width \( w \), so that scattering by interface roughness in wide wells is significantly lower than in narrow wells, which is due to the reduced influence the variation has on the ground-state energy \( E_0 \). This scattering mechanism potentially has a significant influence on the observed reduction in low-temperature mobility in our narrow well samples.

The total mobility can be found from the average transport lifetime in the relaxation time approximation as\(^{21}\)

\[
\mu = \frac{e\langle \tau_d \rangle}{m^*},
\]

where

\[
\frac{1}{\tau_d} = \frac{1}{\tau_{\text{tr}}} + \frac{1}{\tau_{\text{ac}}} + \frac{1}{\tau_{\text{bgi}}} + \frac{1}{\tau_{\text{tr}}} + \frac{1}{\tau_{\text{int}}}.
\]
This results in temperature dependence of the mobility, which is dominant at high temperatures. At low temperatures, the dependence becomes suppressed as the scattering becomes dominated by the impurity scattering terms and, especially in narrow wells, interface roughness scattering. In narrow-gap materials, such as InSb, the conduction band dispersion is nonparabolic, leading to a changing effective mass with energy. This results in temperature dependence of the effective mass, $m^*$, and the density of states. However, the mobility is more strongly dependent on the explicit temperature dependences in Eqs. (3) and (4), and the effects of band nonparabolicity in this context are reduced.

Figure 6 shows that the wide well samples remain somewhat dependent on $d$ and, hence, on ionized impurity scattering at 300 K. This implies that a higher room temperature mobility is potentially achievable. This is demonstrated in Fig. 6, in which the polar optical phonon scattering limits the mobility to around 90 000 cm$^2$/Vs. The absence of any dependence of the high-temperature mobility on the spacer for the narrow well samples (Fig. 5) may be attributed to a stronger dependence on interface roughness scattering.

V. CONCLUSIONS

We have examined the mobility and carrier concentration of a number of InSb-based heterostructures over a range of temperatures from 4.5 to 300 K. Two types of structure have been considered, one with narrow (15 nm) quantum wells and the other with wide (30 nm) quantum wells. Of the two types of heterostructure, the highest low-temperature mobility is achieved by the wide well structures below 40 K; this is found to range from 190 000 to 248 000 cm$^2$/Vs according to the level of doping present in the barrier and the spacer size. As room temperature is approached, the mobilities converge, and at 300 K the wide well sample mobilities are around 50 000 cm$^2$/Vs. The narrower well samples are found to have lower mobilities at low temperatures in the range 63 000–111 000 cm$^2$/Vs, and room temperature mobilities at low temperatures between 34 500 and 39 900 cm$^2$/Vs. This is attributed to the enhanced effect of interface roughness scattering in the narrower wells. At temperatures above 40–50 K, the effects of phonon scattering start to play a role, with the mobility dominated by polar optical phonon scattering at temperatures approaching 300 K. Typical carrier concentrations for these structures are in the ranges $(3.7–5.1)\times10^{11}$ cm$^{-2}$ at 4.5 K and $(5.1–8.0)\times10^{11}$ cm$^{-2}$ at 300 K for the wide well samples and $(2.8–5.7)\times10^{11}$ cm$^{-2}$ at 4.5 K and $(3.7–6.0)\times10^{11}$ cm$^{-2}$ at 300 K for the narrow well samples.
The measured carrier concentration conforms well to predictions from Schrödinger–Poisson calculations that use appropriate parameters.

Transport lifetimes are determined for polar optical and acoustic phonon scatterings, interface roughness scattering, and scattering from charged impurities both in the 3D background and within a distributed “quasi-2D” doping layer. These are combined to give a predicted mobility, which is then compared to the measured mobility data for both types of structure. The comparison is good and is instructive in identifying mobility-limiting scattering mechanisms in the material, and the trend of the data is in good agreement with other theoretical treatments of this material heterostructure.\textsuperscript{30}

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